<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
</tr>
</thead>
<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>002</td>
<td>ChangeMe!</td>
</tr>
</tbody>
</table>

**Variant/Label Table**

**Variant**

**Label Text**

---

**Variant Notes**

**Variant Note**

**Variant** 001

**Label Text** ChangeMe!

---

**Variant** 002

**Label Text** ChangeMe!

---

**Assembly Note**

**Variant** ZZ1

**Label Text** This Assembly Note is for PCB labels only.

---

**Assembly Note**

**Variant** ZZ2

**Label Text** These assemblies are ESD sensitive. ESD precautions shall be observed.

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**Assembly Note**

**Variant** ZZ3

**Label Text** These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.

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**Assembly Note**

**Variant** ZZ4

**Label Text** These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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